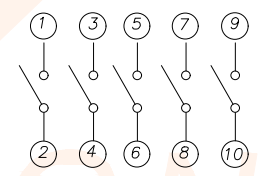
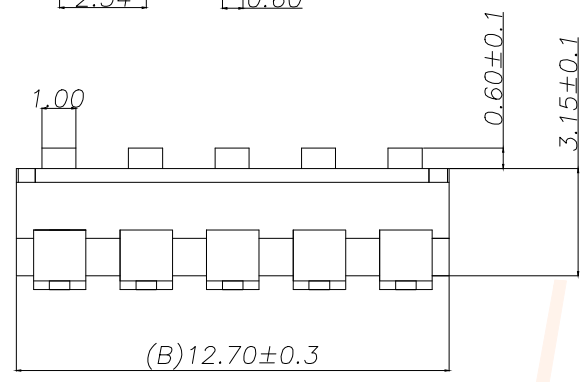
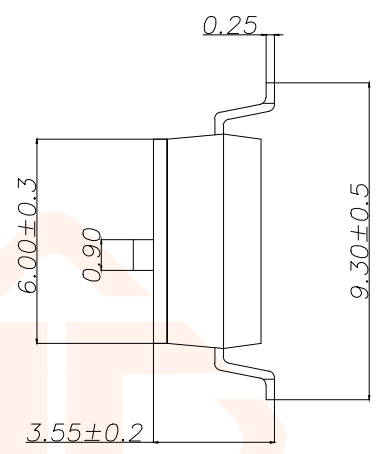
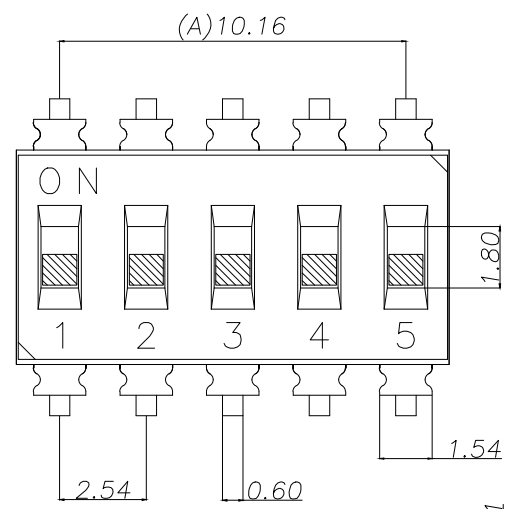
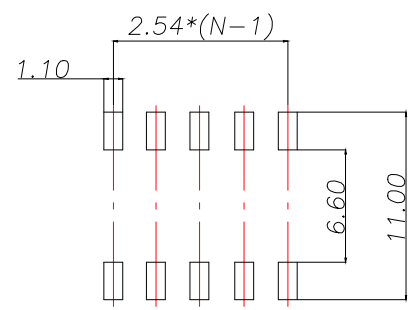




REV.	ECN NO.	DESCRIPTION	DATE	DESIGN



[Schematic]



[P.C.B.LAYOUT]

NOTES:

1.Specification:

- 1>.Operation force: 1000gf Max.
- 2>.Operation Temperature: -30℃ to +85℃.
- 3>.Storage Temperature: -40℃ to +85℃.
- 4>.Mechanical Life: 3000 cycles operations.
- 5>.Resistance to Soldering: 260±5℃ for 3-5 Seconds.

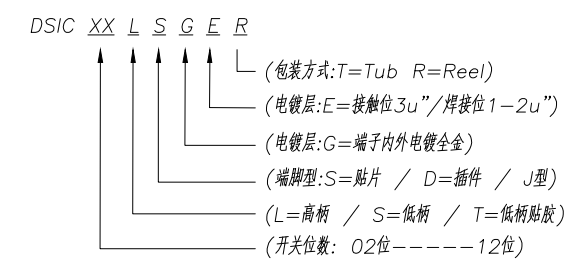
2.PLATING:

- 1>.GOLD flash 1u"(min) SOLDERTAIL,
- 3u" GOLD PLATING ON THE CONTACT AREA.

3.ELECTRICAL:

- 1>.Non-switch Rating:100mA at 50V DC.
- 2>.Switching Rating: 25mA at 24V DC.
- 3>.Contact Resistance: Inital 50mΩ Max.  
Contact Resistance: After life 100mΩ Max.
- 4>.Insulation Resistance:100MΩ Min at 500VDC.
- 5>.Dielectric Strength: 500V AC for 60seconds.
- 6>.Switch Capacitance: 5PF Max at 1MHZ.

4.PART NUMBER DESCRIPTION:



TOLERANCE		深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd			
>0±0.05	>0°±0.5°	PART NO.	TITLE:PRODUCT Family DSIC		
>1±0.10	>5°±1.0°	DSIC05LSGER		Series Pitch 2.54mm	
>10±0.30		DESIGN: Ethan	MANUFACTURE DWG		
UNITS	mm	CHED: Olvia	SCALE SHEET N:A 1/1		
MATERILA	---	APPD: Ava			
FINISH	---				